

### N and P-Channel Enhancement Mode Power MOSFET

### **Description**

The NCE4525 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

#### **General Features**

### N-Channel

 $V_{DS}$  = 40V, $I_D$  =7A

 $R_{DS(ON)}$  < 24m $\Omega$  @  $V_{GS}$ =10V

 $R_{DS(ON)}$  < 38m $\Omega$  @  $V_{GS}$ =4.5V

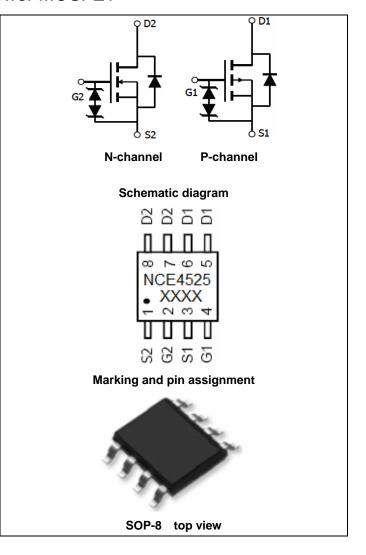
#### P-Channel

 $V_{DS} = -40V, I_{D} = -5A$ 

 $R_{DS(ON)}$  < 38m $\Omega$  @  $V_{GS}$ =-10V

 $R_{DS(ON)}$  <50m $\Omega$  @  $V_{GS}$ =-4.5V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4525	NCE4525	SOP-8	Ø330mm	12mm	2500 units

# Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parame	Symbol	N-Channel	P-Channel	Unit		
Drain-Source Voltage		V <sub>DS</sub>	40	-40	V	
Gate-Source Voltage		V <sub>GS</sub>	±12	±12	V	
Continuous Drain Current	T <sub>A</sub> =25℃		7	-5	^	
Continuous Drain Current	T <sub>A</sub> =70°C	I <sub>D</sub>	5.8	-4.2	Α	
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	30	-30	Α	
Maximum Power Dissipation	T <sub>A</sub> =25℃	P <sub>D</sub>	2.0	2.0	W	
Operating Junction and Storage T	$T_{J}$ , $T_{STG}$	-55 To 150	-55 To 150	$^{\circ}$		

#### **Thermal Characteristic**



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# NCE4525

Thermal Resistance,Junction-to-Ambient (Note2)	$R_{\theta JA}$	N-Ch	62.5	°C/W
Thermal Resistance, Junction-to-Ambient (Note2)	$R_{ heta JA}$	P-Ch	62.5	°C/W

# N-CH Electrical Characteristics ( $T_A$ =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	40	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μΑ
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1	1.5	2	V
Drain Course On Otata Basistana	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =6A	-	19.5	24	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A	-	29	38	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =6A	15	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ 00\/\/ 0\/	-	516	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =20V, $V_{GS}$ =0V, F=1.0MHz	-	82	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVITIZ	-	43	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	4.5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =15V, $R_L$ =2.5 $\Omega$	-	2.5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	14.5	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	3.5	-	nS
Total Gate Charge	Qg	\/ -20\/ L -CA	-	8.9	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =20V, $I_{D}$ =6A, $V_{GS}$ =10V	-	2.4	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	VGS-10V	-	1.4	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =6A	-	0.8	1.2	V

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# NCE4525

# P-CH Electrical Characteristics (T<sub>A</sub>=25 °C unless otherwise noted)

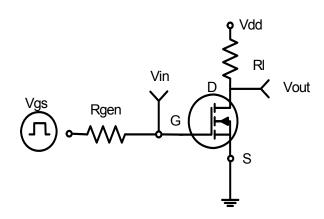
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-40	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V	-	-	-1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μA	
On Characteristics (Note 3)	·						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}$ = $V_{GS}$ , $I_D$ =-250 $\mu$ A	-1.0	-1.5	-2.0	V	
Drain-Source On-State Resistance	В	V <sub>GS</sub> =-10V, I <sub>D</sub> =-5A	-	32	38	mΩ	
Diam-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	-	39	50	mΩ	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-5A	10	-	-	S	
Dynamic Characteristics (Note4)	·						
Input Capacitance	C <sub>lss</sub>	\/ 00\/\\ 0\/	-	940	-	PF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =-20V, $V_{GS}$ =0V, F=1.0MHz	-	97	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0ivinz	-	72	-	PF	
Switching Characteristics (Note 4)	·						
Turn-on Delay Time	t <sub>d(on)</sub>		-	6.2	-	nS	
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-20V, $R_L$ =2.3 $\Omega$	-	8.4	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10 $V$ , $R_{GEN}$ =6 $\Omega$	-	44.8	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	16	-	nS	
Total Gate Charge	Qg	\/ - 20\/ L - FA	-	17	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-20V, $I_D$ =-5A $V_{GS}$ =-10V	-	3.4	-	nC	
Gate-Drain Charge	$Q_{gd}$	v <sub>GS</sub> 10v	-	3.2	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-5A	-	-	-1.2	V	

#### Notes:

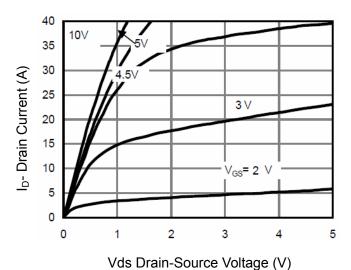
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



## N- Channel Typical Electrical and Thermal Characteristics (Curves)



**Figure 1:Switching Test Circuit** 



**Figure 3 Output Characteristics** 

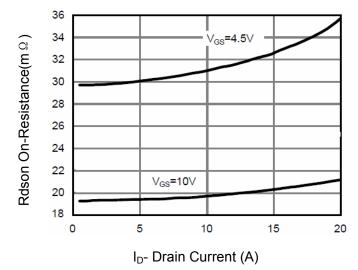
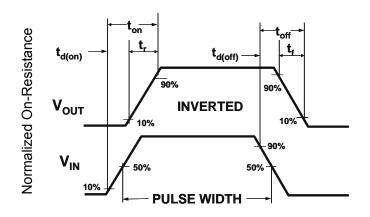
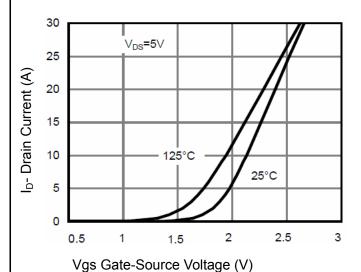


Figure 5 Drain-Source On-Resistance



**Figure 2:Switching Waveforms** 



**Figure 4 Transfer Characteristics** 

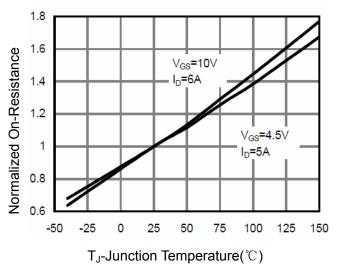


Figure 6 Drain-Source On-Resistance



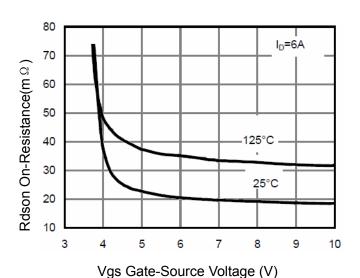


Figure7 Rdson vs Vgs

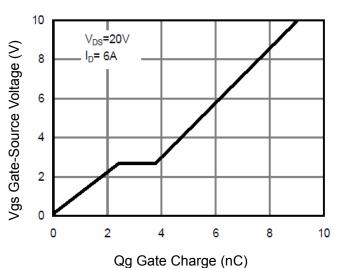


Figure 9 Gate Charge

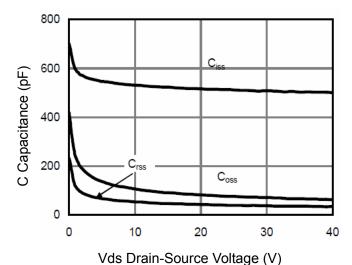
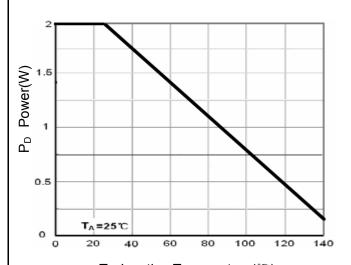


Figure 11 Capacitance vs Vds



T<sub>J</sub>-Junction Temperature(°C)

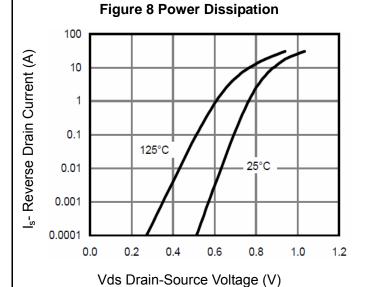
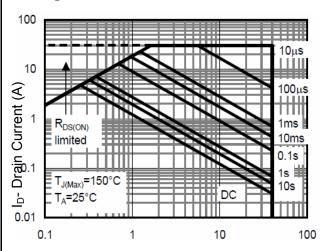
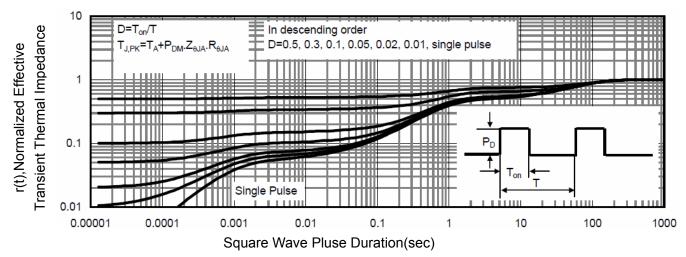


Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)
Figure 12 Safe Operation Area





**Figure 13 Normalized Maximum Transient Thermal Impedance** 



# P- Channel Typical Electrical and Thermal Characteristics (Curves)

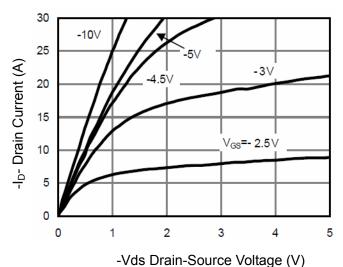
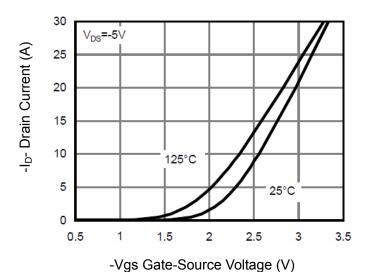


Figure 1 Output Characteristics



**Figure 2 Transfer Characteristics** 

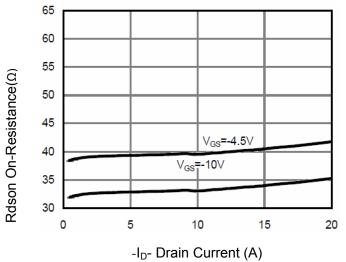
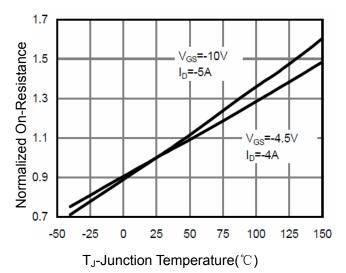
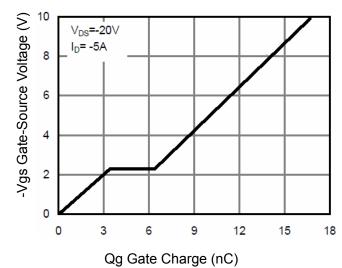


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 



**Figure 5 Gate Charge** 

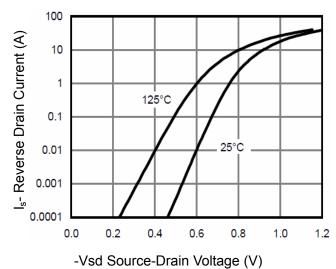
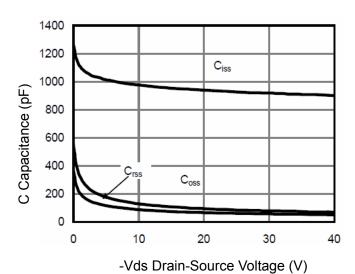
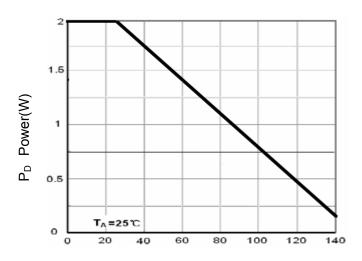


Figure 6 Source- Drain Diode Forward







T<sub>J</sub>-Junction Temperature(°C)

Figure 9 Power Dissipation

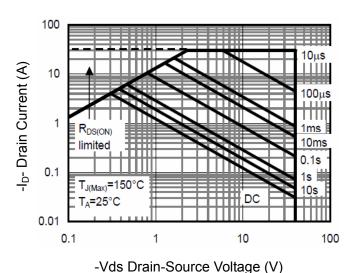


Figure 7 Capacitance vs Vds

Figure 8 Safe Operation Area

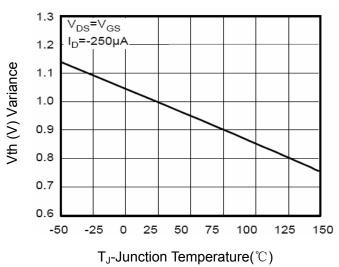
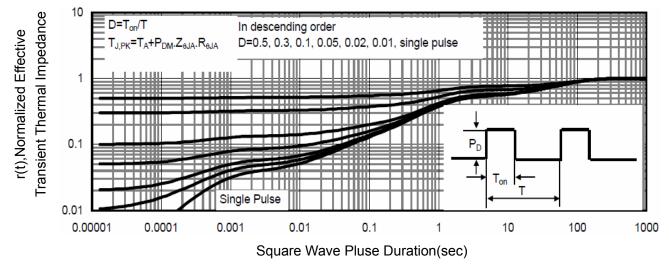


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

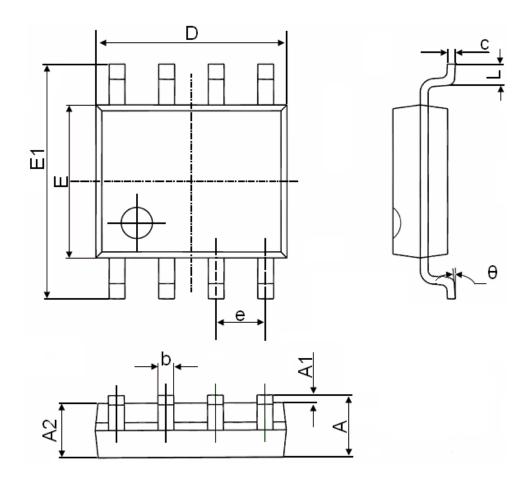


**Figure 11 Normalized Maximum Transient Thermal Impedance** 

**Pb Free Product** 

# NCE4525

# **SOP-8 Package Information**



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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NCE4525

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